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5822110-3 Product Details

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5822110-3

TE Internal Number: 5822110-3 Active

Memory Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Socket Type = Memory Card Socket Style = SIMM
- Tin Contact Plating, Mating Area, Material
- ٠ 72 Positions
- 1,27 mm Centerline

View all Features









Documentation & Additional Information

Documents are temporarily unavailable. We are working hard to correct the problem. Please try again later.

Additional Information:

Product Line Information

Additional Product Images:

Product Photo

Related Products:

Tooling

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Socket Style = SIMM
- PCB Mount Style = Through Hole
- Module Orientation = 22°
- Proprietary Name = MICRO-EDGE
- Polarization = Left

Mechanical Attachment:

Center Retention Hole Diameter (mm [in]) = 2.45 [0.096]

Termination Related Features:

- Termination Post Length (mm [in]) = 2.92 [0.115], 3.56 [0.140]
- Solder Tail Contact Plating = Tin over Nickel

Body Related Features:

- Socket Type = Memory Card
- Number of Positions = 72
- Centerline (mm [in]) = 1.27 [0.050]
- Number of Rows = Single
- Ejector Location = None
- · Center Post = With
- · Latch Material = Stainless Steel
- · Mount Type = Printed Circuit Board

Contact Related Features:

- · Contact Plating, Mating Area, Material = Tin
- Contact Base Material = Phosphor Bronze
- Retention Post(s) Location = Center

Housing Related Features:

- Housing Material = Liquid Crystal Polymer (LCP)
- UL Flammability Rating = UL 94V-0

Configuration Related Features:

- Insertion Style = Cam-In
- Center Key (mm [in]) = None

Industry Standards:

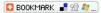
- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- <u>Lead Free Solder Processes</u> = Wave solder capable to 240°C, Wave solder capable to 260°C, Wave solder capable to 265°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Packaging Related Features:

Packaging Method = Tube

Other:

Brand = AMP



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